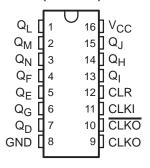
## SN54HC4060, SN74HC4060 14-STAGE ASYNCHRONOUS BINARY COUNTERS AND OSCILLATORS

SCLS161D - DECEMBER 1982 - REVISED SEPTEMBER 2003

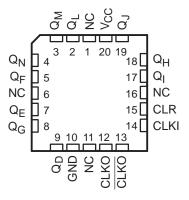
- Wide Operating Voltage Range of 2 V to 6 V
- Outputs Can Drive Up To 10 LSTTL Loads
- Low Power Consumption, 80-μA Max I<sub>CC</sub>
- Typical t<sub>pd</sub> = 14 ns

SN54HC4060 . . . J OR W PACKAGE SN74HC4060 . . . D, DB, N, NS, OR PW PACKAGE (TOP VIEW)



- ±4-mA Output Drive at 5 V
- Low Input Current of 1 μA Max
- Allow Design of Either RC- or Crystal-Oscillator Circuits

# SN54HC4060 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

### description/ordering information

The 'HC4060 devices consist of an oscillator section and 14 ripple-carry binary counter stages. The oscillator configuration allows design of either RC- or crystal-oscillator circuits. A high-to-low transition on the clock (CLKI) input increments the counter. A high level at the clear (CLR) input disables the oscillator (CLKO goes high and CLKO goes low) and resets the counter to zero (all Q outputs low).

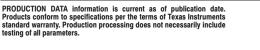
#### **ORDERING INFORMATION**

TA	PACKA	GE <sup>†</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube of 25	SN74HC4060N	SN74HC4060N
		Tube of 40	SN74HC4060D	
−40°C to 85°C	SOIC - D	Reel of 2500	SN74HC4060DR	HC4060
		Reel of 250	SN74HC4060DT	
	SOP - NS	Reel of 2000	SN74HC4060NSR	HC4060
	SSOP - DB	Reel of 2000	SN74HC4060DBR	HC4060
		Tube of 90	SN74HC4060PW	
	TSSOP - PW	Reel of 2000	SN74HC4060PWR	HC4060
		Reel of 250	SN74HC4060PWT	
	CDIP – J	Tube of 25	SNJ54HC4060J	SNJ54HC4060J
–55°C to 125°C	CFP – W	Tube of 150	SNJ54HC4060W	SNJ54HC4060W
	LCCC – FK	Tube of 55	SNJ54HC4060FK	SNJ54HC4060FK

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



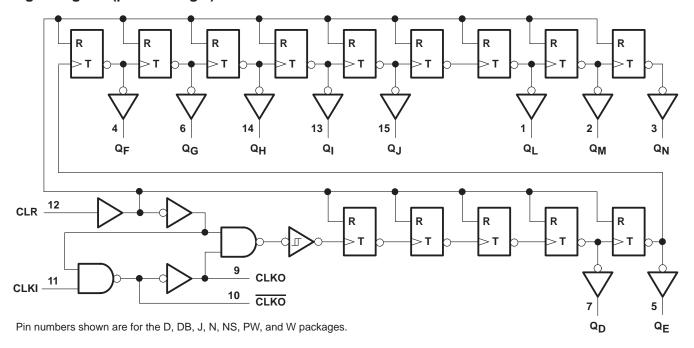
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



# FUNCTION TABLE (each buffer)

	INPL	JTS	FUNCTION
C	LK	CLR	FUNCTION
_	<b>↑</b>	L	No change
	$\downarrow$	L	Advance to next stage
)	X	Н	All outputs L

### logic diagram (positive logic)



# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Input clamp current, $I_{IK}$ ( $V_I$ < 0 or $V_I$ > $V_{CC}$ ) (see Output clamp current, $I_{OK}$ ( $V_O$ < 0 or $V_O$ > $V_{CC}$ ) (Continuous output current, $I_O$ ( $V_O$ = 0 to $V_{CC}$ ) Package thermal impedance, $\theta_{JA}$ (see Note 2): D	-0.5 V to 7 V  Note 1) ±20 mA (see Note 1) ±20 mA  2 package 73°C/W  B package 82°C/W  I package 67°C/W  IS package 64°C/W  W package 108°C/W
Storage temperature range, T <sub>stg</sub>	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. The package thermal impedance is calculated in accordance with JESD 51-7.



# SN54HC4060, SN74HC4060 14-STAGE ASYNCHRONOUS BINARY COUNTERS AND OSCILLATORS

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## recommended operating conditions (see Note 3)

			SN	54HC40	60	SN	74HC40	60	LINUT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		2	5	6	2	5	6	V
		V <sub>CC</sub> = 2 V	1.5			1.5			
VIH	High-level input voltage	V <sub>CC</sub> = 4.5 V	3.15			3.15			V
		V <sub>CC</sub> = 6 V	4.2			4.2			
		V <sub>CC</sub> = 2 V			0.5			0.5	
VIL	V <sub>IL</sub> Low-level input voltage	V <sub>CC</sub> = 4.5 V			1.35			1.35	V
		VCC = 6 V			1.8			1.8	
٧ı	Input voltage		0		VCC	0		VCC	V
Vo	Output voltage		0		VCC	0		VCC	V
		V <sub>CC</sub> = 2 V			1000			1000	
Δt/Δν	Input transition rise/fall time	V <sub>CC</sub> = 4.5 V			500			500	ns
		V <sub>CC</sub> = 6 V			400			400	
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					Т	A = 25°C	;	SN54H	C4060	SN74H0	C4060	
PAR	AMETER	TEST CO	NDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
				2 V	1.9	1.998		1.9		1.9		
	All outputs	VI = VIH or VIL,	$I_{OH} = -20  \mu A$	4.5 V	4.4	4.499		4.4		4.4		
Vон				6 V	5.9	5.999		5.9		5.9		V
	0	V VV	$I_{OH} = -4 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84		
	Q outputs	$V_I = V_{IH}$ or $V_{IL}$	$I_{OH} = -5.2 \text{ mA}$	6 V	5.48	5.8		5.2		5.34		
				2 V		0.002	0.1		0.1		0.1	
	All outputs	VI = VIH or VIL,	$I_{OL} = 20 \mu A$	4.5 V		0.001	0.1		0.1		0.1	
$V_{OL}$				6 V		0.001	0.1		0.1		0.1	V
	O acceptance de	Mr. Mr. an Mr.	I <sub>OL</sub> = 4 mA	4.5 V		0.17	0.26		0.4		0.33	
	Q outputs	$V_I = V_{IH}$ or $V_{IL}$	I <sub>OL</sub> = 5.2 mA	6 V		0.15	0.26		0.4		0.33	
lį		$V_I = V_{CC}$ or 0		6 V		±0.1	±100		±1000		±1000	nA
ICC		$V_I = V_{CC}$ or 0,	IO = 0	6 V			8		160		80	μΑ
Ci	_					3	10		10		10	pF

# SN54HC4060, SN74HC4060 14-STAGE ASYNCHRONOUS BINARY COUNTERS AND OSCILLATORS

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# timing requirements over recommended operating free-air temperature range (unless otherwise noted)

			.,	T <sub>A</sub> =	25°C	SN54H	C4060	SN74H	C4060		
			VCC	MIN	MAX	MIN	MAX	MIN	MAX	UNIT	
			2 V		5.5		3.7		4.3		
f <sub>clock</sub> Clock frequency			4.5 V		28		19		22	MHz	
			6 V		33		22		25		
			2 V	90		135		115			
		CLKI high or low	CLKI high or low	4.5 V	18		27		23		
	Dulas duration		6 V	15		23		20			
t <sub>W</sub>	Pulse duration		2 V	90		135		115		ns	
		CLR high	4.5 V	18		27		23			
			6 V	15		23		20			
			2 V	160		240		200			
t <sub>su</sub>	t <sub>SU</sub> Setup time, CLR inactive before CLKI↓		4.5 V	32		48		40		ns	
			6 V	27		41		34			

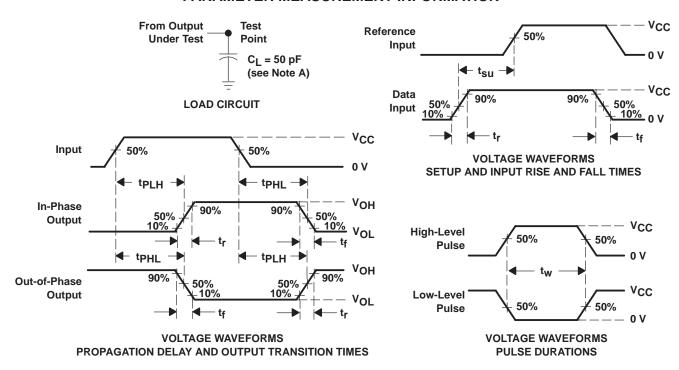
# switching characteristics over recommended operating free-air temperature range, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

545445755	FROM	то	,,	T	λ = 25°C	;	SN54H	C4060	SN74H	C4060	
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V	5.5	10		3.7		4.3		
f <sub>max</sub>			4.5 V	28	45		19		22		MHz
			6 V	33	53		22		25		
			2 V		240	490		735		615	
<sup>t</sup> pd	CLKI	Q <sub>D</sub>	4.5 V		58	98		147		123	ns
·			6 V		42	83		125		105	
			2 V		66	140		210		175	
<sup>t</sup> PHL	CLR	Any Q	4.5 V		18	28		42		35	ns
			6 V		14	24		36		30	
			2 V	_	28	75		110		95	
t <sub>t</sub>		Any	4.5 V	_	8	15		22		19	ns
·			6 V		6	30		19		16	

# operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance	No load	88	pF

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and test-fixture capacitance.

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \ \Omega$ ,  $t_\Gamma = 6 \ ns$ ,  $t_f = 6 \ ns$ .
- C. For clock inputs, f<sub>max</sub> is measured when the input duty cycle is 50%.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. tpLH and tpHL are the same as tpd.

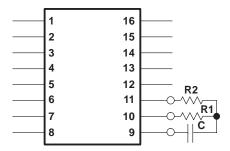
Figure 1. Load Circuit and Voltage Waveforms

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### CONNECTING AN RC-OSCILLATOR CIRCUIT TO THE 'HC4060 DEVICES

The 'HC4060 devices consist of an oscillator section and 14 ripple-carry binary counter stages. The oscillator configuration allows design of either RC- or crystal-oscillator circuits.

When an RC-oscillator circuit is implemented, two resistors and a capacitor are required. The components are attached to the terminals as shown:



To determine the values of capacitance and resistance necessary to obtain a specific oscillator frequency (f), use this formula:

$$f = \frac{1}{2(R1)(C)\left(\frac{0.405 R2}{R1 + R2} + 0.693\right)}$$

If R2 > > R1 (i.e., R2 = 10R1), the above formula simplifies to:

$$f = \frac{0.455}{RC}$$

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#### **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN54HC4060FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54HC 4060FK	Samples
SN74HC4060D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC4060	Samples
SN74HC4060DBR	ACTIVE	SSOP	DB	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC4060	Samples
SN74HC4060DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC4060	Samples
SN74HC4060DT	ACTIVE	SOIC	D	16	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC4060	Samples
SN74HC4060N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-40 to 85	SN74HC4060N	Samples
SN74HC4060NSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC4060	Samples
SN74HC4060NSRE4	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC4060	Samples
SN74HC4060PW	ACTIVE	TSSOP	PW	16	90	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC4060	Samples
SN74HC4060PWR	ACTIVE	TSSOP	PW	16	2000	RoHS & Green	NIPDAU   SN	Level-1-260C-UNLIM	-40 to 85	HC4060	Samples
SN74HC4060PWRG4	ACTIVE	TSSOP	PW	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC4060	Samples
SN74HC4060PWT	ACTIVE	TSSOP	PW	16	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC4060	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".



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(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54HC4060, SN74HC4060:

Catalog: SN74HC4060

Automotive: SN74HC4060-Q1, SN74HC4060-Q1

Military: SN54HC4060

#### NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

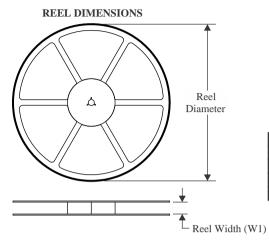
• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

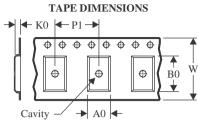
• Military - QML certified for Military and Defense Applications



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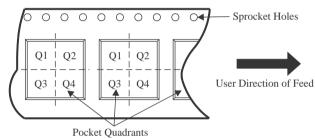
### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

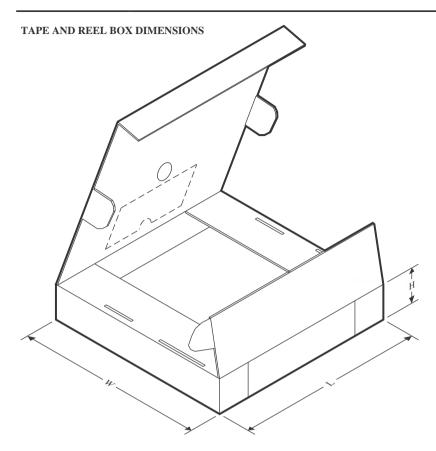


#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74HC4060DBR	SSOP	DB	16	2000	330.0	16.4	8.35	6.6	2.4	12.0	16.0	Q1
SN74HC4060DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74HC4060DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74HC4060NSR	so	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74HC4060PWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74HC4060PWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74HC4060PWRG4	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74HC4060PWT	TSSOP	PW	16	250	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1



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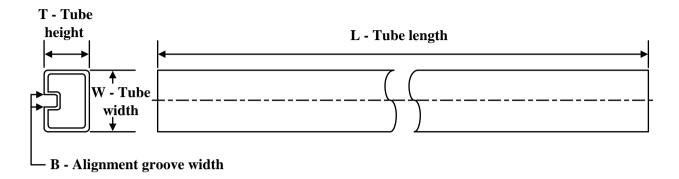
### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74HC4060DBR	SSOP	DB	16	2000	356.0	356.0	35.0
SN74HC4060DR	SOIC	D	16	2500	356.0	356.0	35.0
SN74HC4060DR	SOIC	D	16	2500	340.5	336.1	32.0
SN74HC4060NSR	so	NS	16	2000	356.0	356.0	35.0
SN74HC4060PWR	TSSOP	PW	16	2000	364.0	364.0	27.0
SN74HC4060PWR	TSSOP	PW	16	2000	356.0	356.0	35.0
SN74HC4060PWRG4	TSSOP	PW	16	2000	356.0	356.0	35.0
SN74HC4060PWT	TSSOP	PW	16	250	356.0	356.0	35.0

# **PACKAGE MATERIALS INFORMATION**

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### **TUBE**



\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN54HC4060FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SN74HC4060D	D	SOIC	16	40	506.6	8	3940	4.32
SN74HC4060D	D	SOIC	16	40	507	8	3940	4.32
SN74HC4060N	N	PDIP	16	25	506	13.97	11230	4.32
SN74HC4060N	N	PDIP	16	25	506	13.97	11230	4.32
SN74HC4060PW	PW	TSSOP	16	90	530	10.2	3600	3.5

# N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOP



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



SOF

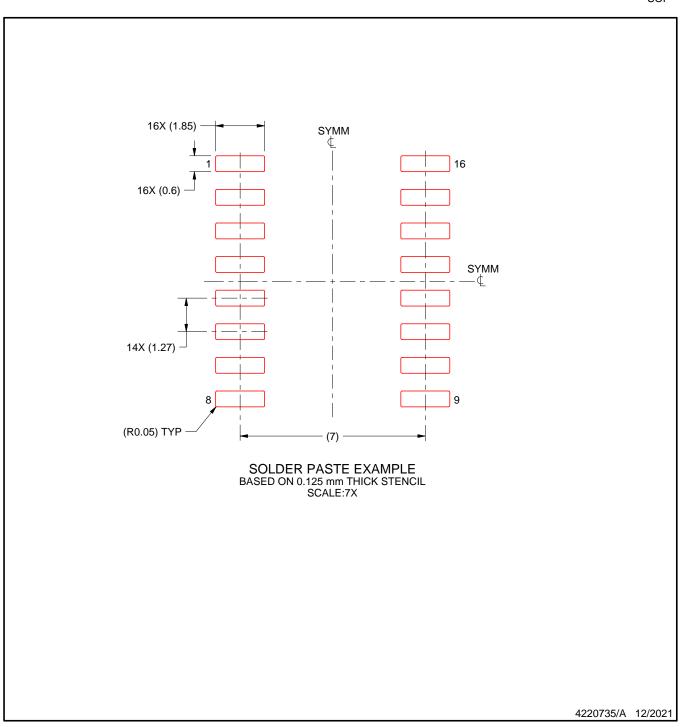


### NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOF



#### NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



# D (R-PDS0-G16)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



# D (R-PDSO-G16)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.







- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.





NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



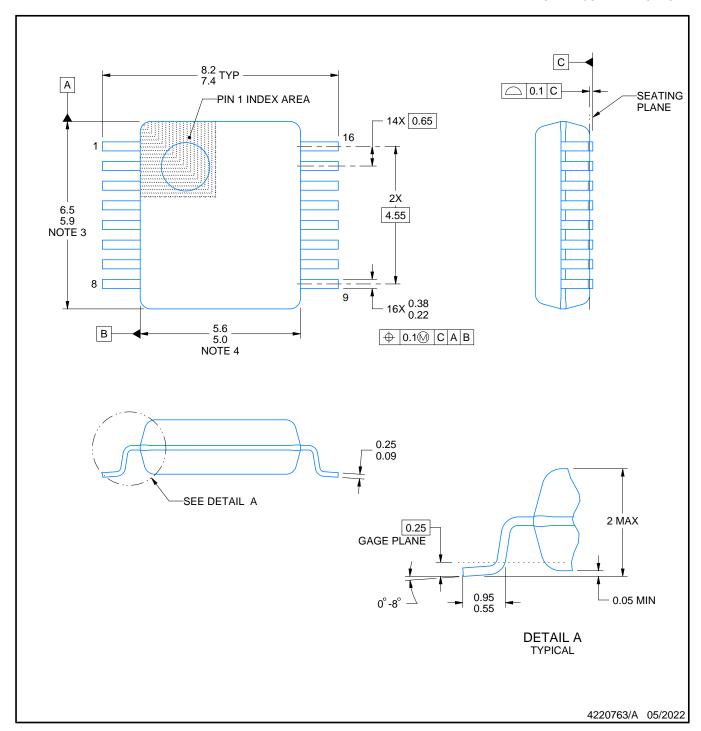


NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.







- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
  4. Reference JEDEC registration MO-150.

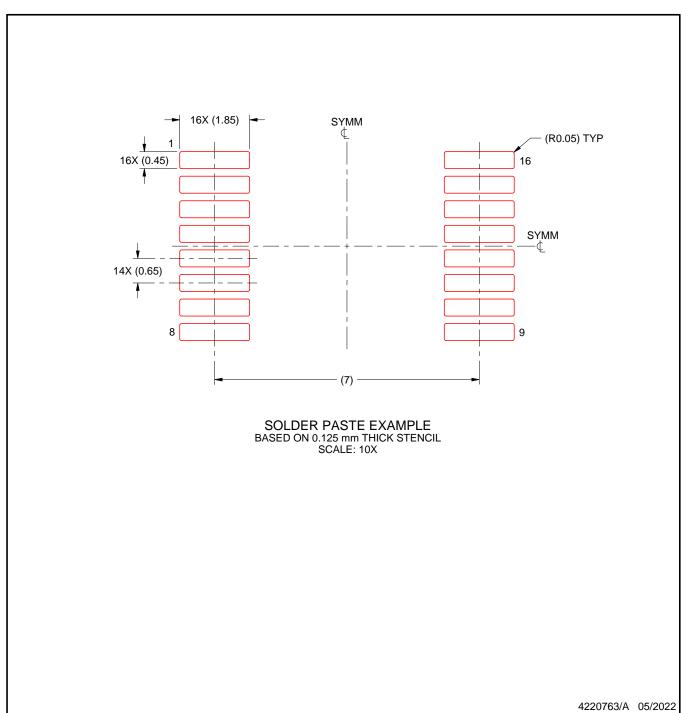




NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.

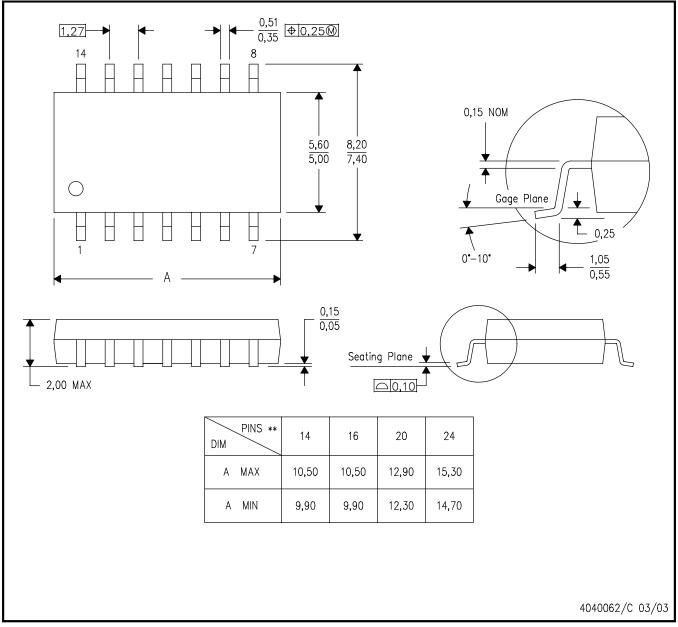


## **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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